



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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**RoHS
Compliant**

**Flangeless
Termination
125 Watts**



General Specifications

Resistive Element	Thick film
Substrate	ALN Ceramic
Cover	Alumina Ceramic
Terminal Finish	Matte Tin over Sulfamate Nickel
Operating Temperature	-55 to +150°C (see chart)

Tolerance is ± 0.010 ", unless otherwise specified. Designed to meet or exceed applicable portions of MIL-E-5400. All dimensions in inches.

Features:

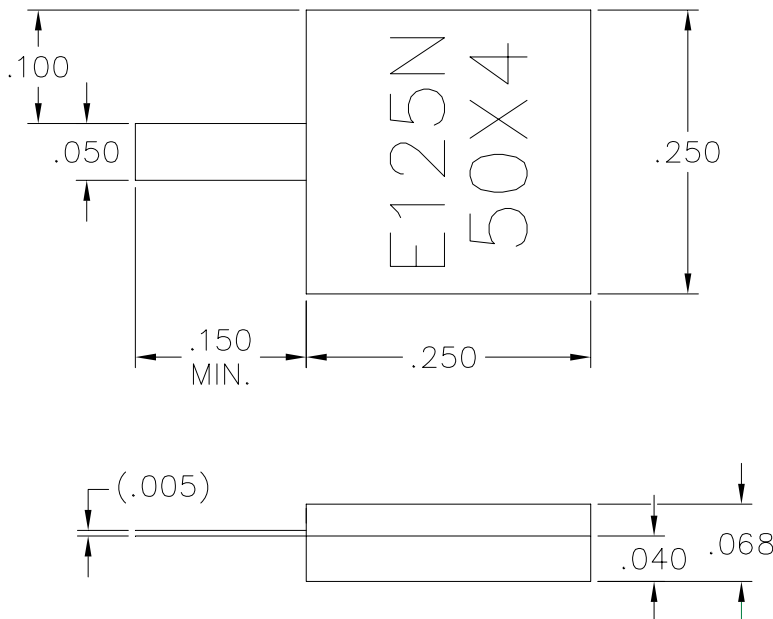
- 125 Watts
- AlN Ceramic Substrate
- Non-Nichrome Resistive Element
- Low VSWR
- High power
- 100% Tested

Electrical Specifications

Resistance:	50 Ohms
Power:	125 Watts
Frequency Range:	DC – 3.0 GHz
V.S.W.R.:	1.25 : 1

Specification based on unit properly installed using suggested mounting instructions and a 50 ohm nominal impedance. **Specifications subject to change.**

Outline Drawing

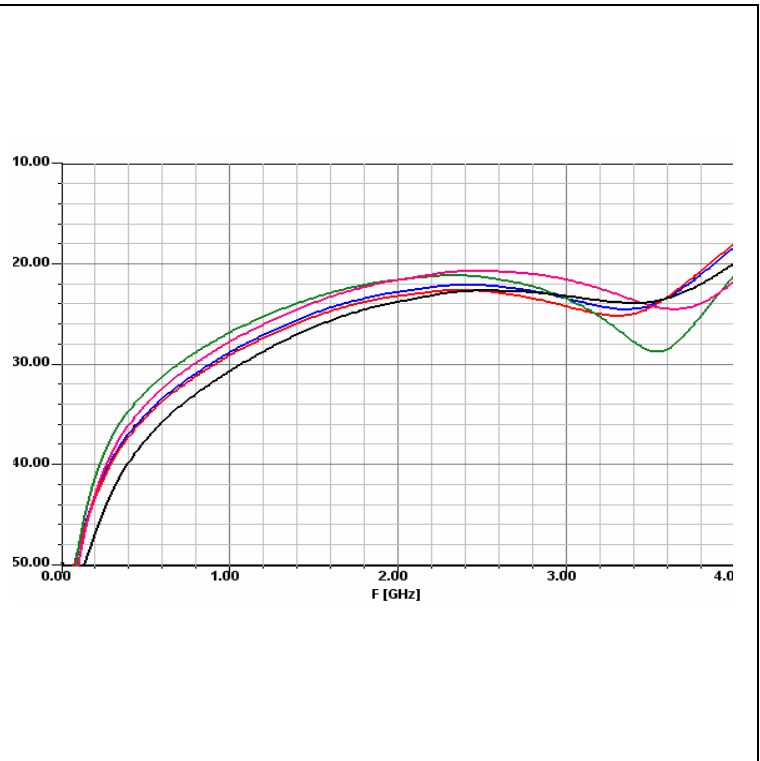
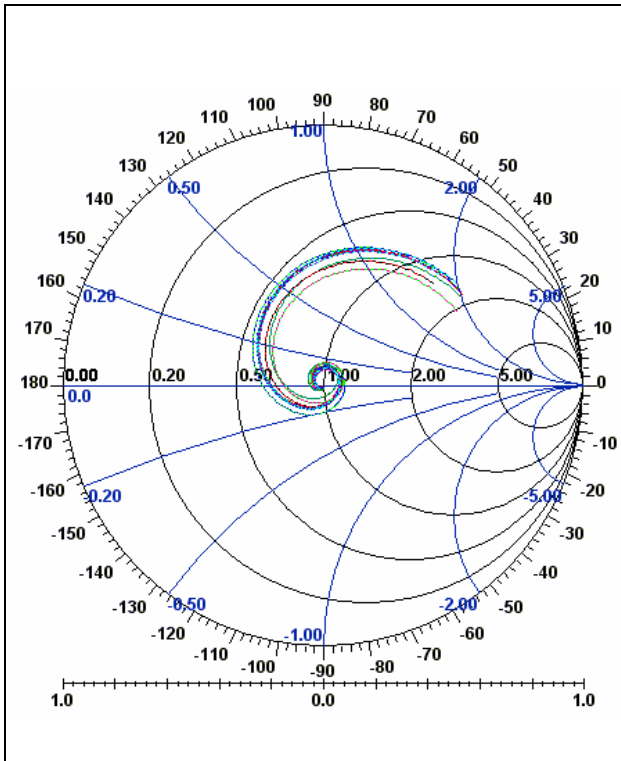


Dimensions given in inches.

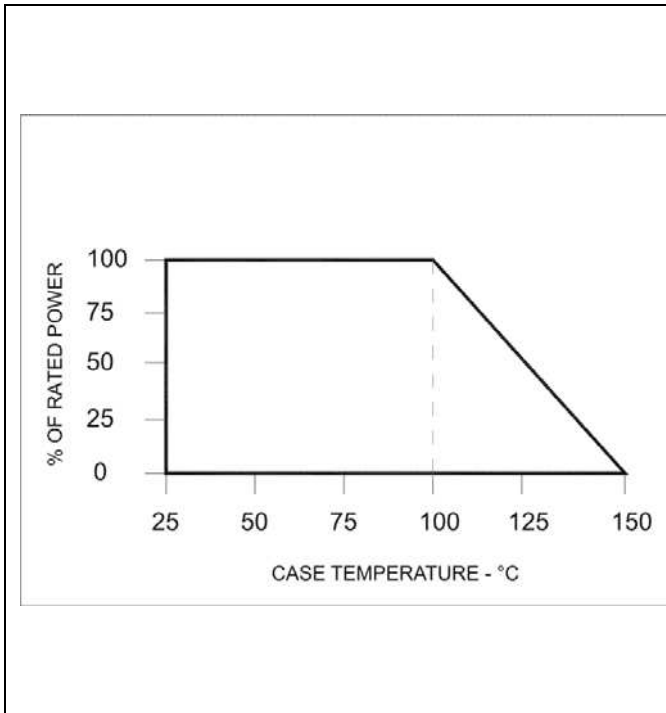
E125N50X4 (097) Rev B



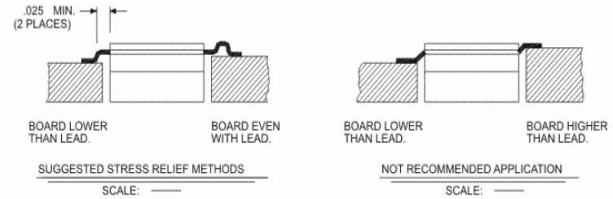
Typical Performance:



Power De-rating:



Mounting Footprint and Procedure:



1. Make sure that the devices are mounted on flat surfaces (0.001" under the device) to optimize the heat transfer.
2. Drill & tap the heatsink for the appropriate thread size to be used.
3. Coat the heatsink with a minimum amount of high quality silicone grease (0.001" max. thickness).
4. Position the device on mounting surface and secure using socket head screws, flat & split washers. Torque screws to the appropriate value. Make sure that the device is flat against the heatsink. (Care should be taken to avoid upward pressure of the leads toward the lid).
5. Solder leads in place using an adequate solder with a controlled temperature iron.

E125N50X4 (097) Rev B

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Available on Tape and Reel For Pick and Place Manufacturing.



Anaren
 What'll we think of next?™